DATA SHEET



SKY73020-11: 700 – 1000 MHz High Gain and Linearity Diversity Downconversion Mixer for 2G/3G Base Station Transceiver Applications

Applications

- 2G/3G base station transceivers:
 GSM/EDGE, CDMA, UMTS/WCDMA, iDEN
- Land mobile radio
- ISM band transceivers
- High performance radio links
- RF identification

Features

- Operating frequency range: 700 to 1000 MHz
- IF frequency range: 50 to 250 MHz
- Conversion gain: 7.0 dB
- Input IP3: 27.0 dBm
- Output IP3: 34.0 dBm
- Noise figure: 10.2 dB
- Integrated LO drivers
- Integrated low-loss RF baluns
- High linearity IF amplifiers
- On-chip SPDT LO switch (greater than 65 dB LO-to-LO isolation)
- Small, MCM (36-pin, 6 x 6 mm) Pb-free package (MSL3, 260 °C per JEDEC J-STD-020)



Skyworks offers lead (Pb)-free RoHS (Restriction of Hazardous Substances) compliant packaging.

Description

The SKY73020-11 is a fully integrated diversity mixer that includes Local Oscillator (LO) drivers, an LO switch, high linearity mixers, and large dynamic range Intermediate Frequency (IF) amplifiers. Low-loss RF baluns have also been included to reduce design complications and lower system cost.

The SKY73020-11 features an input IP3 of 27.0 dBm and a Noise Figure (NF) of 10.2 dB, making the device an ideal solution for high dynamic range systems such as 2G/3G base station receivers. The LO switch provides more than 65 dB of isolation between LO inputs and supports the switching time required for GSM/EDGE base stations.

The SKY73020-11 is manufactured using a robust silicon BiCMOS process and has been designed for optimum long-term reliability. The SKY73020-11 diversity downconversion mixer is provided in a compact, 36-pin 6 x 6 mm Multi-Chip Module (MCM). A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

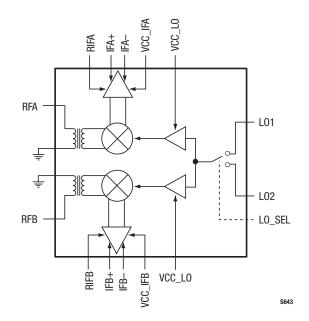


Figure 1. SKY73020-11 Block Diagram

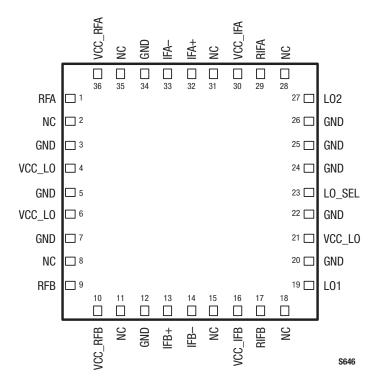


Figure 2. SKY73020-11 Pinout – 36-Pin MCM

Table 1.	SKY73020-11	Signal Descri	ptions
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Pin #	Name	Description	Pin #	Name	Description
1	RFA	Channel A RF input	19	L01	Local oscillator 1 input
2	NC	No connect	20	GND	Ground
3	GND	Ground	21	VCC_LO	DC supply, +5 V
4	VCC_LO	DC supply, +5 V	22	GND	Ground
5	GND	Ground	23	L0_SEL	Local oscillator select switch control
6	VCC_LO	DC supply, +5 V	24	GND	Ground
7	GND	Ground	25	GND	Ground
8	NC	No connect	26	GND	Ground
9	RFB	Channel B RF input	27	L02	Local oscillator 2 input
10	VCC_RFB	Channel B RF DC supply, +5 V	28	NC	No connect
11	NC	No connect	29	RIFA	Channel A IF bias adjust
12	GND	Ground	30	VCC_IFA	Channel A IF DC supply, +5 V
13	IFB+	Positive channel B IF output	31	NC	No connect
14	IFB-	Negative channel B IF output	32	IFA+	Positive channel A IF output
15	NC	No connect	33	IFA-	Negative channel A IF output
16	VCC_IFB	Channel B IF DC supply, +5 V	34	GND	Ground
17	RIFB	Channel B IF bias adjust	35	NC	No connect
18	NC	No connect	36	VCC_RFA	Channel A RF DC supply, +5 V

Functional Description

The SKY73020-11 is a high gain diversity mixer, optimized for base station receiver applications. The device consists of two diversity channels (A and B), each consisting of a low-loss RF balun, high linearity passive mixer, and a low-noise IF amplifier.

Two LO amplifiers (independent of channels A and B) are also included that allow the SKY73020-11 to connect directly to the output of a Voltage Controlled Oscillator (VCO). This eliminates the extra gain stages needed by most discrete passive mixers. A Single-Pole, Double-Throw (SPDT) switch has been included to select between two different LO inputs for frequency hopping applications (i.e., GSM).

RF Baluns and Passive Mixer

The RF baluns provide a single-ended input, which can easily be matched to 50 Ω using a simple external matching circuit. The RF baluns offer very low loss, and excellent amplitude and phase balance.

The high linearity SKY73020-11 is a passive, double balanced mixer that provides a very low conversion loss and an excellent 3rd Order Input Intercept Point (IIP3).

Additionally, the balanced nature of the mixer provides for high port-to-port isolation.

LO Buffers and SPDT LO Switch

The LO buffers allow the input power of the SKY73020-11 to be in the range of ± 3 dBm. The LO section is optimized for low-side LO injection. However, each of the two LOs can be driven over a wide frequency range with only slight degradation in performance.

A high isolation SPDT switch allows the SKY73020-11 to be used for frequency hopping applications. This switch provides greater than 65 dB of L01 to L02 isolation:

LO_SEL Input	L0 Path Selected		
High	LO1 (pin 19) enabled		
Low	LO2 (pin 27) enabled		

For applications that do not require frequency hopping, L0_SEL is fixed to one state and the appropriate L0 input is used. An internal pull-down resistor enables the L02 input.

IF Amplifier

The SKY73020-11 includes high dynamic range IF amplifiers that follow the passive mixers in the signal path. The outputs require a supply voltage connection using inductive chokes. These choke inductors should be high-Q and have the ability to handle 200 mA or greater.

A simple matching network allows the output ports to be matched to a balanced 200 Ω impedance. The IF amplifiers are optimized for IF frequencies between 50 and 250 MHz. The IF amplifiers can be operated outside of this range, but with a slight degradation in performance.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY73020-11 are provided in Table 2 and the recommended operating conditions in Table 3. Electrical characteristics for the SKY73020-11 are provided in Table 4.

Typical performance characteristics of the SKY73020-11 are illustrated in Figures 3 through 39.

Table 2. SKY73020-11 Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage (VCC_L0, VCC_RFB, VCC_IFB, VCC_IFA, and VCC_RFA)	VCC		5.5	V
Supply current	lcc		420	mA
RF input power	Prf		20	dBm
L0 input power	Plo		6	dBm
Operating case temperature	Tc	-40	+85	°C
Storage case temperature	Tstg	-40	+150	°C

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value.

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage (VCC_LO, VCC_RFB, VCC_IFB, VCC_IFA, and VCC_RFA)	VCC	4.75	5.00	5.25	V
Supply current	lcc		370	420	mA
LO input power	PLO	-3	0	+3	dBm
LO_SEL input: high low	LO_SELH LO_SELL	2.2		0.8	V V
Operating case temperature	Tc	-40		+85	°C
RF frequency range	FRF	700		1000	MHz
LO frequency range (Note 1)	FLO	625		950	MHz
IF frequency range	FIF	50		250	MHz

Table 3. SKY73020-11 Recommended Operating Conditions

Note 1: The SKY73020-11 has been optimized for low side L0 injection. However, the L0 can be used outside of the specified frequency range with degraded performance.

Table 4. SKY73020-11 Electrical Specifications (1 of 2)

(VCC = +5 V, T_c = +25 °C, LO Input Power = 0 dBm, RF Frequency = 900 MHz, IF Frequency = 70 MHz, LO Frequency = 830 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Conversion gain	G		5.0	7.0	8.0	dB
Noise Figure	NF			10.2	13.0	dB
Noise Figure with a blocker signal	NFblk	Blocking signal input power = +8 dBm			23	dB
Third order input intercept point	IIP3	Tone spacing = 800 kHz , Input power = -10 dBm each tone		27.0		dBm
Third order output intercept point	OIP3	Tone spacing = 800 kHz , Input power = -10 dBm each tone	32.5	34.0		dBm
2RF – 2L0	2x2	$P_{RF} = -10 \text{ dBm}$			-63	dBc
3RF – 3L0	3x3	$P_{RF} = -10 \text{ dBm}$			-70	dBc
Input 1 dB compression point	IP1dB			16.5		dBm
Output 1 dB compression point	OP1dB		19.0	22.5		dBm
L01-to-L02 isolation				65		dB
Channel-to-channel isolation				46		dB
RF-to-IF isolation				75		dB
LO leakage: @ RF port @ IF port				45 80	-30	dBm dBm
L0_SEL input			-20	+150	+250	μA
LO switching time					1	μS

Table 4. SKY73020-11 Electrical Specifications (2 of 2) (VCC = +5 V, T_c = +25 °C, L0 Input Power = 0 dBm, RF Frequency = 900 MHz, IF Frequency = 70 MHz, L0 Frequency = 830 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF port input return loss	Zin_rf	With external matching components	-14			dB
L0 port input return loss	Zin_lo	With external matching components	-14			dB
IF port input return loss	Zout_if	With external matching components	-14			dB

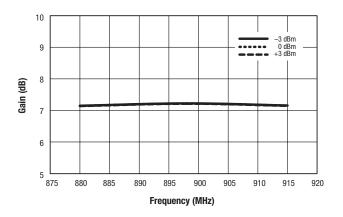


Figure 3. Mixer A Gain vs Frequency and LO Power

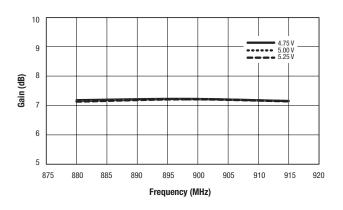


Figure 5. Mixer A Gain vs Frequency and Supply Voltage

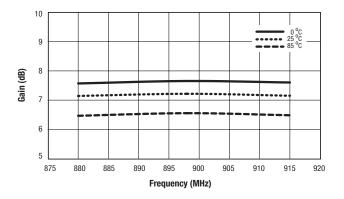


Figure 4. Mixer A Gain vs Frequency and Temperature

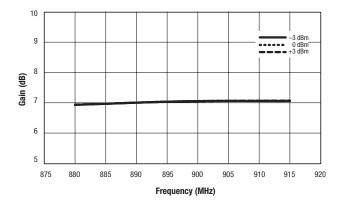


Figure 6. Mixer B Gain vs Frequency and LO Power

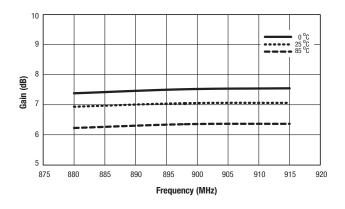


Figure 7. Mixer B Gain vs Frequency and Temperature

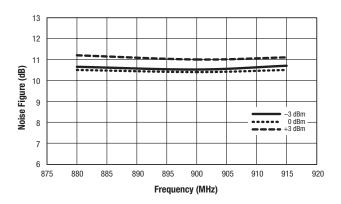


Figure 9. Mixer A Noise Figure vs Frequency and LO Power

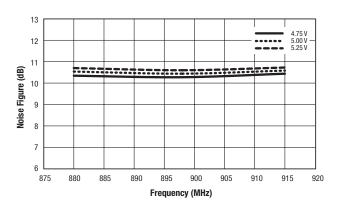


Figure 11. Mixer A Noise Figure vs Frequency and Supply Voltage

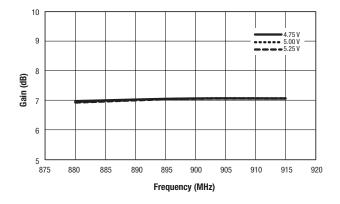


Figure 8. Mixer B Gain vs Frequency and Supply Voltage

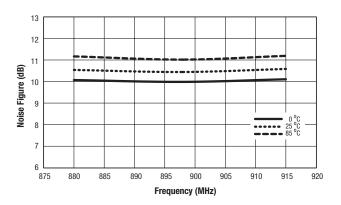


Figure 10. Mixer A Noise Figure vs Frequency and Temperature

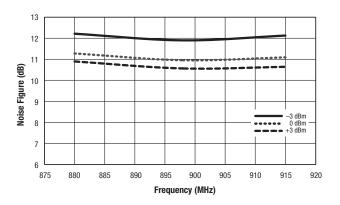


Figure 12. Mixer B Noise Figure vs Frequency and LO Power

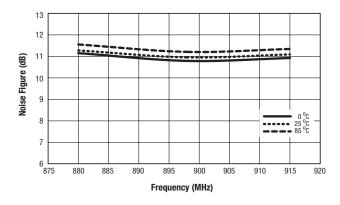


Figure 13. Mixer B Noise Figure vs Frequency and Temperature

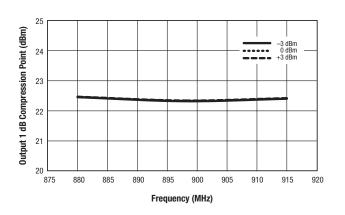


Figure 15. Mixer A OP1dB vs Frequency and LO Power

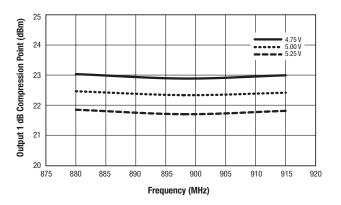


Figure 17. Mixer A OP1dB vs Frequency and Supply Voltage

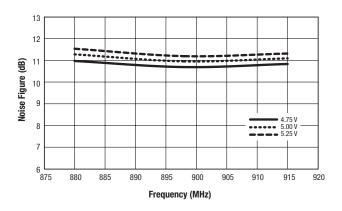


Figure 14. Mixer B Noise Figure vs Frequency and Supply Voltage

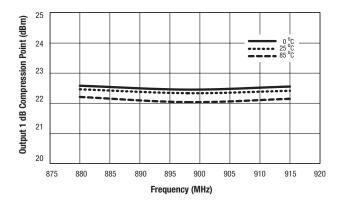


Figure 16. Mixer A OP1dB vs Frequency and Temperature

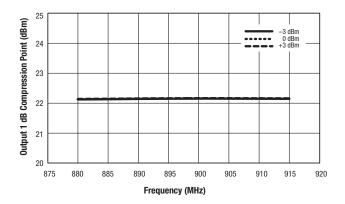


Figure 18. Mixer B OP1dB vs Frequency and LO Power

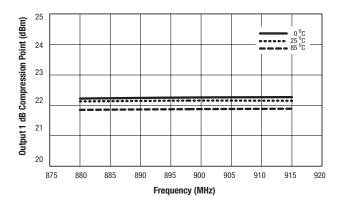


Figure 19. Mixer B OP1dB vs Frequency and Temperature

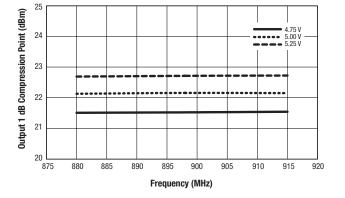


Figure 20. Mixer B OP1dB vs Frequency and Supply Voltage

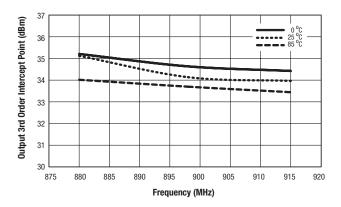


Figure 22. Mixer A OIP3 vs Frequency and Temperature

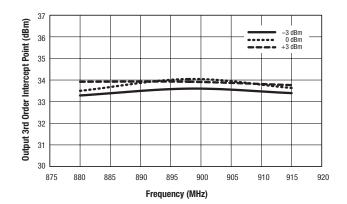


Figure 24. Mixer B OIP3 vs Frequency and LO Power

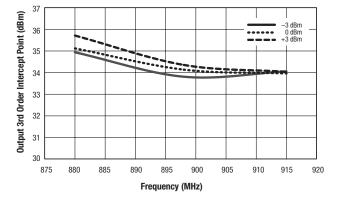


Figure 21. Mixer A OIP3 vs Frequency and LO Power

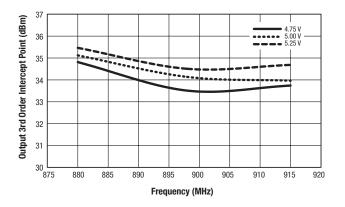


Figure 23. Mixer A OIP3 vs Frequency and Supply Voltage

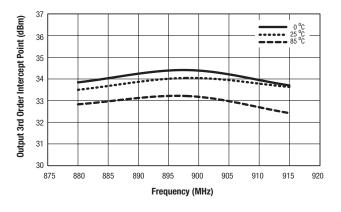


Figure 25. Mixer B OIP3 vs Frequency and Temperature

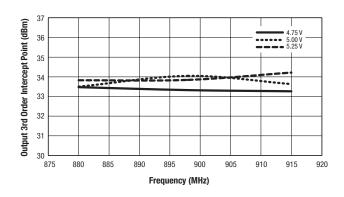


Figure 26. Mixer B OIP3 vs Frequency and Supply Voltage

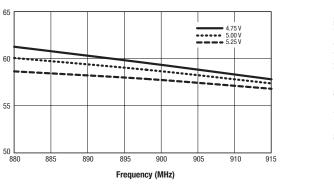


Figure 27. Channel A To Channel B Isolation vs Frequency and Supply Voltage

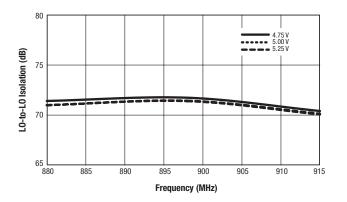


Figure 29. L01-To-L02 Isolation vs Frequency and Supply Voltage

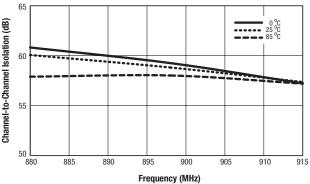


Figure 28. Channel A To Channel B Isolation vs Frequency and Temperature

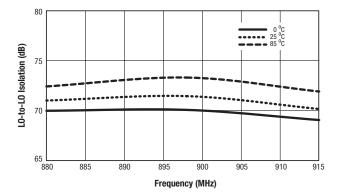


Figure 30. L01-To-L02 Isolation vs Frequency and Temperature

Channel-to-Channel Isolation (dB)

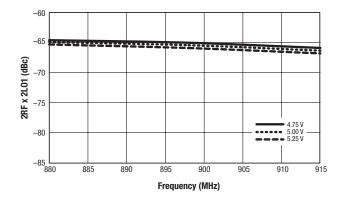


Figure 31. Channel A 2RF – 2LO vs Frequency and Supply Voltage

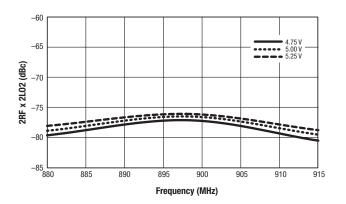


Figure 33. Channel B 2RF – 2LO vs Frequency and Supply Voltage

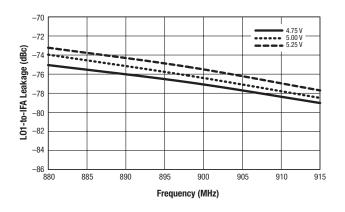


Figure 35. Channel A L01-to-IF Leakage vs Frequency and Supply Voltage

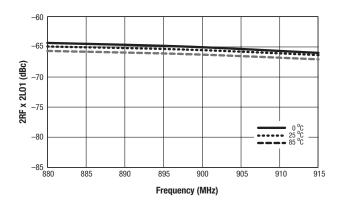


Figure 32. Channel A 2RF – 2LO vs Frequency and Temperature

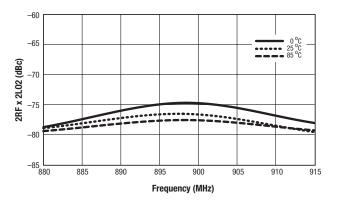


Figure 34. Channel B 2RF – 2LO vs Frequency and Temperature

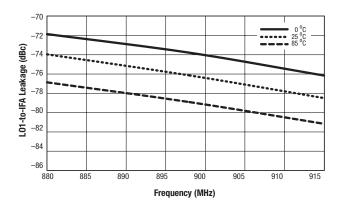


Figure 36. Channel A L01-to-IF Leakage vs Frequency and Temperature

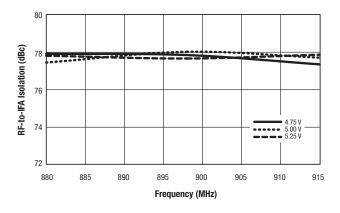


Figure 37. Channel A RF-to-IF Isolation vs Frequency and Supply Voltage

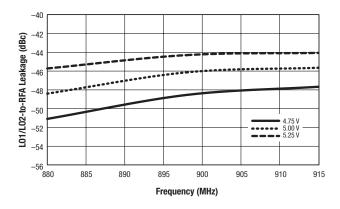


Figure 39. Channel A LO1-to-RF Leakage vs Frequency and Supply Voltage

Evaluation Board Description

The SKY73020-11 Evaluation Board is used to test the performance of the SKY73020-11 downconversion mixer. An assembly drawing for the Evaluation board is shown in Figure 41 and the layer detail is provided in Figure 42.

Circuit Design Considerations

The following design considerations are general in nature and must be followed regardless of final use or configuration:

- 1. Paths to ground should be made as short and as low impedance as possible.
- 2. The ground pad of the SKY73020-11 provides critical electrical and thermal functionality. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. Therefore, design the connection to the

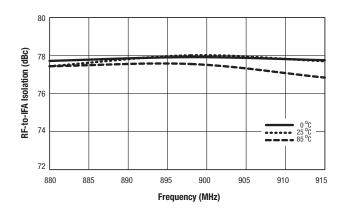


Figure 38. Channel A RF-to-IF Isolation vs Frequency and Temperature

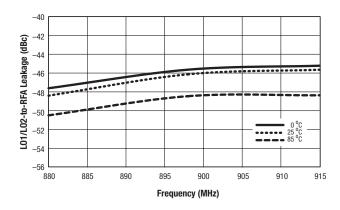


Figure 40. Channel A L01-to-RF Leakage vs Frequency and Temperature

ground pad to dissipate the maximum heat produced by the circuit board. For more information on soldering the SKY73020-11, refer to the Package and Handling Information section of this Data Sheet.

- Skyworks recommends including external bypass capacitors on the VCC voltage inputs of the device.
- Components L5, L6, L14, and L15 (see Figure 3) are high-Q, low-loss inductors. These inductors must be able to pass currents in excess of 200 mA DC.
- Components R1 and R2 (see Figure 3) allow for external adjustment of the IF amplifier bias points. For operation as specified in Tables 3 and 4, these resistors are not required.

A schematic diagram for the SKY73020-11 Evaluation Board is shown in Figure 43.

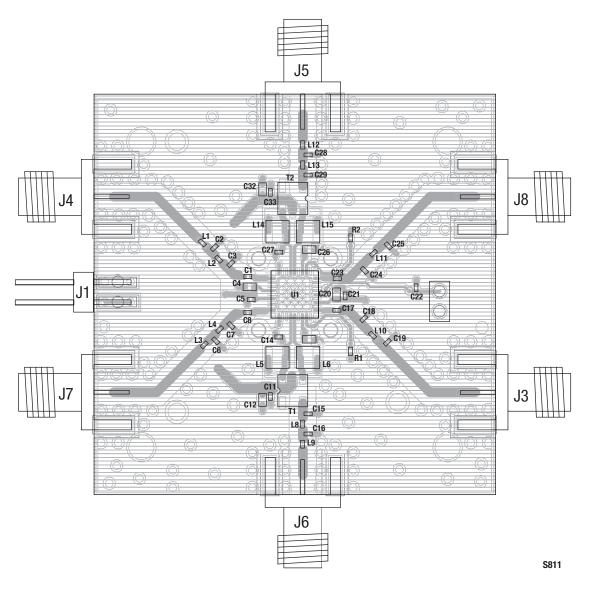
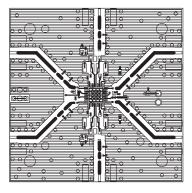
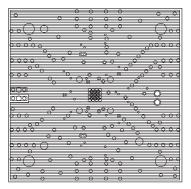


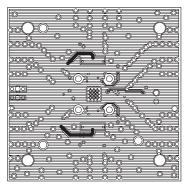
Figure 41. SKY73020-11 Evaluation Board Assembly Diagram



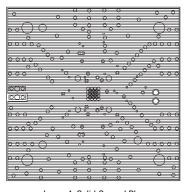
Layer 1: Top -- Metal



Layer 2: Ground



Layer 3: Power Plane



Layer 4: Solid Ground Plane

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Figure 42. SKY73020-11 Evaluation Board Layer Detail

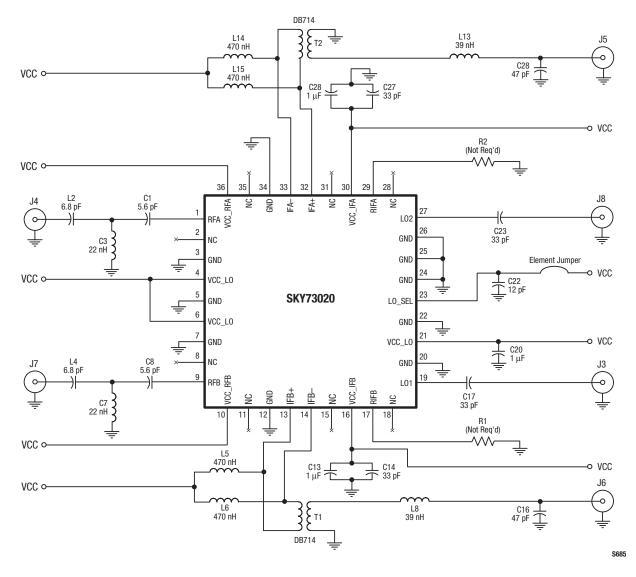


Figure 43. SKY73020-11 Evaluation Board Schematic

Package Dimensions

The PCB layout footprint for the SKY73020-11 is provided in Figure 44. Figure 45 shows the package dimensions for the 36-pin MCM and Figure 46 provides the tape and reel dimensions.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

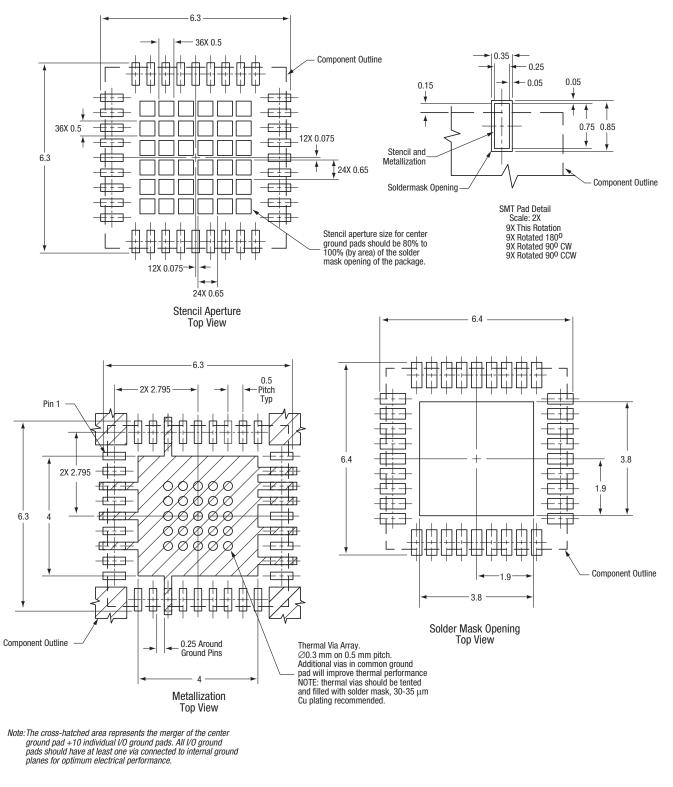
THE SKY73020-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For

additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format. For packaging details, refer to the Skyworks Application Note, *Tape and Reel*, document number 101568.

Electrostatic Discharge (ESD) Sensitivity

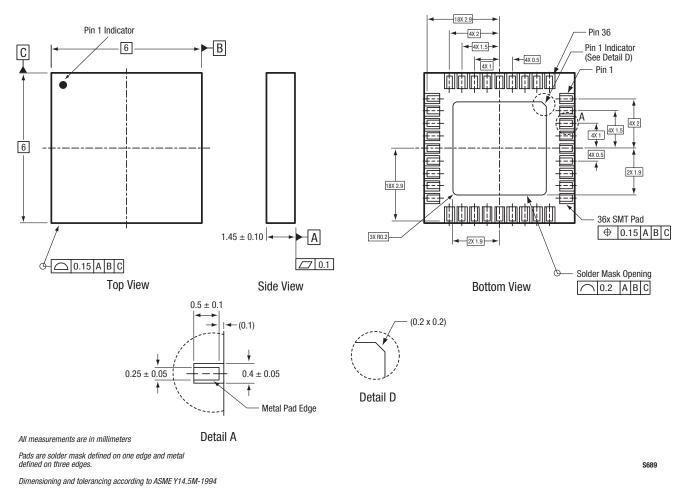
The SKY73020-11 is a static-sensitive electronic device. Do not operate or store near strong electrostatic fields. Take proper ESD precautions.



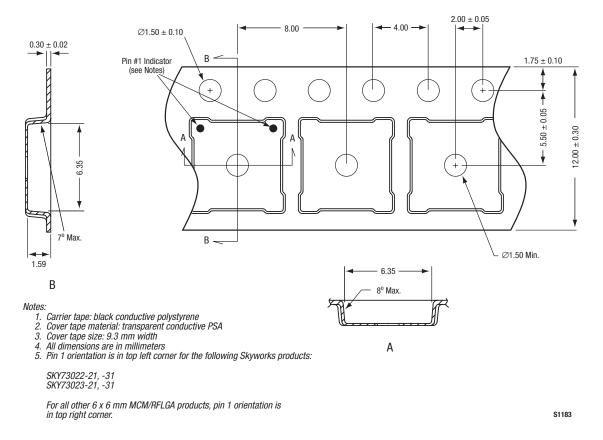
All measurements are in millimeters

S1125

Figure 44. PCB Layout Footprint for the SKY73020-11 6 x 6 mm MCM









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Ordering Information

Model Name	Manufacturing Part Number	Evaluation Kit Part Number
SKY73020-11 Downconversion Mixer	SKY73020-11 (Pb-free package)	TW17-D660

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